# SPDT, 1 $\Omega$ R<sub>ON</sub> Switch

The NLAS4157 is a low  $R_{ON}$  SPDT analog switch. This device is designed for low operating voltage, high current switching of speaker output for cell phone applications. It can switch a balanced stereo output. The NLAS4157 can handle a balanced microphone/speaker/ringtone generator in a monophone mode. The device contains a break–before–make (BBM) feature.

#### **Features**

• Single Supply Operation:

1.65 V to 5.5 V V<sub>CC</sub> Function Directly from LiON Battery

• Tiny SC88 6-Pin Pb-Free Package:

Meets JEDEC MO-220 Specifications

- $R_{ON}$  Typical = 0.8  $\Omega$  @  $V_{CC}$  = 4.5 V
- Low Static Power
- This is a Pb-Free Device

#### **Typical Applications**

- Cell Phone Speaker/Microphone Switching
- Ringtone-Chip/Amplifier Switching
- Stereo Balanced (Push-Pull) Switching

#### Important Information

- Ringtone-Chip/Amplifier Switching
- Continuous Current Rating Through each Switch ±300 mA
- Conforms to: JEDEC MO-220, Issue H, Variation VEED-6
- Pin for Pin Compatible with FSA4157



#### ON Semiconductor®

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SC-88 (SOT-363) CASE 419B

#### MARKING DIAGRAM

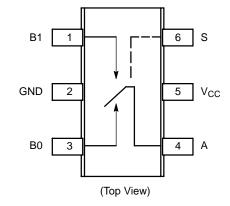


AN

= Specific Device Code

M = Date Code

#### **PIN ASSIGNMENTS**



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

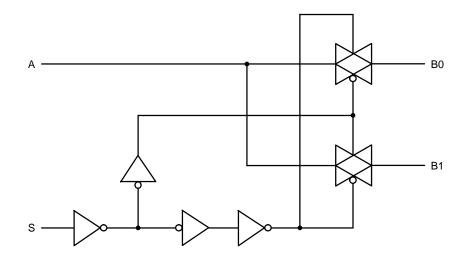


Figure 1. Input Equivalent Circuit

#### **PIN DESCRIPTION**

Pin Name	Description
A, B0, B1	Data Ports
S	Control Input

#### **TRUTH TABLE**

Control Input	Function
L	B0 Connected to A
Н	B1 Connected to A

H = HIGH Logic Level. L = LOW Logic Level.

#### **MAXIMUM RATINGS**

Symbol	Rating	Value	Unit
V <sub>CC</sub>	Positive DC Supply Voltage	-0.5 to +6.0	V
V <sub>IS</sub>	Analog Input Voltage (V <sub>NO</sub> , V <sub>NC</sub> , or V <sub>COM</sub> )	-0.5 to V <sub>CC</sub> +0.5	V
V <sub>IN</sub>	Digital Select Input Voltage	-0.5 to +6.0	V
I <sub>anl1</sub>	Continuous DC Current from COM to NC/NO	±300	mA
I <sub>anl-pk1</sub>	Peak Current from COM to NC/NO, 10 Duty Cycles (Note 1)	±500	mA
I <sub>clmp</sub>	Continuous DC Current into COM/NC/NO with respect to V <sub>CC</sub> or GND	±100	mA

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Defined as 10% ON, 90% off duty cycle.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Rating	Min	Max	Unit	
V <sub>CC</sub>	Positive DC Supply Voltage		1.65	5.5	V
V <sub>IS</sub>	Analog Input Voltage (A, B0, B1)		0	V <sub>CC</sub>	V
V <sub>IN</sub>	Digital Select Input Voltage (S)		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range		-40	85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Time, SELECT	V <sub>CC</sub> = 3.0 V V <sub>CC</sub> = 5.5 V		20 10	ns/V

#### DC ELECTRICAL CHARACTERISTICS

			v <sub>cc</sub>	T <sub>A</sub> = +25°C			T <sub>A</sub> = -40°0		
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage		2.7 4.5				2.0 2.4		V
V <sub>IL</sub>	LOW Level Input Voltage		2.7 4.5					0.6 0.8	V
I <sub>IN</sub>	Input Leakage Current	$0 \le V_{IN} \le 5.5 V$	0-5.5			±0.1		±1	μΑ
I <sub>OFF</sub>	OFF State Leakage Current (Note 7)	0 ≤ A, B ≤ V <sub>CC</sub>	5.5	-2.0		+2.0		±20	nA
I <sub>ON</sub>	ON State Leakage Current (Note 7)	0 ≤ A, B ≤ V <sub>CC</sub>	5.5	-4.0		+4.0		±40	nA
R <sub>ON</sub>	Switch On Resistance (Note 2)	$I_{O} = -100 \text{ mA},$ $B_{0} \text{ or } B_{1} = 3.5 \text{ V}$	2.7		2.0	4.0		4.3	Ω
		$I_O = -100 \text{ mA},$ $B_0 \text{ or } B_1 = 1.5 \text{ V}$	4.5		0.8	1.15		1.3	
I <sub>CC</sub>	Quiescent Supply Current All Channels ON or OFF	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	5.5			0.5		1.0	μА

#### **Analog Signal Range**

ΔR <sub>ON</sub>	On Resistance Match Between Channels (Notes 2, 3, 4)	$I_A = -100 \text{ mA},$ $B_0 \text{ or } B_1 = 1.5 \text{ V}$ $I_A = -100 \text{ mA},$ $B_0 \text{ or } B_1 = 3.5 \text{ V}$	2.7 4.5	0.15 0.12		0.15	Ω
R <sub>flat</sub>	On Resistance Flatness (Notes 2, 3, 5)	$\begin{split} I_A &= -100 \text{ mA}, \\ B_0 \text{ or } B_1 &= 0 \text{ V}, 0.75 \text{ V}, 1.5 \text{ V} \\ I_A &= -100 \text{ mA}, \\ B_0 \text{ or } B_1 &= 0 \text{ V}, 1.0 \text{ V}, 2.0 \text{ V} \end{split}$	2.7 4.5	1.4 0.3		0.4	Ω

<sup>2.</sup> Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B Ports).

Parameter is characterized but not tested in production.
 DR<sub>ON</sub> = R<sub>ON</sub> max - R<sub>ON</sub> min measured at identical V<sub>CC</sub>, temperature and voltage levels.
 Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of conditions.

<sup>6.</sup> Guaranteed by Design.

<sup>7.</sup> This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

#### **AC ELECTRICAL CHARACTERISTICS**

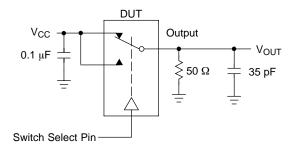
		Test Conditions	V <sub>CC</sub>	T,	<sub>A</sub> = +25°	C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			Figure
Symbol	Parameter		(V)	Min	Тур	Max	Min	Max	Unit	#
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Bus-to-Bus (Note 9)	V <sub>I</sub> = OPEN	2.7 4.5			2.0 0.3			ns	3, 4
t <sub>ON</sub>	Output Enable Time Turn On Time (A to B <sub>n</sub> )	$B_0$ or $B_1 = 1.5$ V, $R_L = 50 \Omega$ , $C_L = 35$ pF $B_0$ or $B_1 = 3.0$ V,	2.7 4.5			30 20		35 25	ns	3, 4
t <sub>OFF</sub>	Output Disable Time	$R_L = 50 \Omega, C_L = 35 pF$ $B_0 \text{ or } B_1 = 1.5 V,$	2.7			20		25	ns	3, 4
	Turn Off Time (A Port to B Port)	$R_L = 50 \Omega$ , $C_L = 35 pF$ $B_0 \text{ or } B_1 = 3.0 \text{ V}$ , $R_L = 50 \Omega$ , $C_L = 35 pF$	4.5			15		20		
t <sub>BBM</sub>	Break Before Make Time (Note 8)		2.7	0.5			0.5		ns	2
			4.5	0.5			0.5			
Q	Charge Injection (Note 8)	$C_L = 1.0 \text{ nF}, V_{GEN} = 0 \text{ V}$ $R_{GEN} = 0 \Omega$	2.7 4.5		26 48				pC	6
O <sub>IRR</sub>	Off Isolation (Note 10)	$R_L = 50 \Omega$ f = 1.0 MHz	2.7 – 5.5		-52				dB	5
X <sub>talk</sub>	Crosstalk	$R_L = 50 \Omega$ f = 1.0 MHz	2.7 – 5.5		-57				dB	7
BW	-3 dB Bandwidth	R <sub>L</sub> = 50 Ω	2.7 – 5.5		40				MHz	8
THD	Total Harmonic Distortion (Note 8)	$R_L = 600 \Omega$ 0.5 $V_{P-P}$ f = 20 Hz to 20 kHz	2.7 – 5.5		0.012				%	9

#### **CAPACITANCE** (Note 11)

Symbol	Parameter	Test Conditions	Тур	Max	Unit	Figure #
C <sub>IN</sub>	Select Pin Input Capacitance	V <sub>CC</sub> = 0 V, f = 1 MHz	10		pF	
C <sub>IO-B</sub>	B Port Off Capacitance	V <sub>CC</sub> = 4.5 V, f = 1 MHz	25		pF	
C <sub>IOA-ON</sub>	A Port Capacitance when Switch is Enabled	V <sub>CC</sub> = 4.5 V, f = 1 MHz	87		pF	

<sup>11.</sup>  $T_A$  = +25°C, f = 1 MHz, Capacitance is characterized but not tested in production.

<sup>8.</sup> Guaranteed by Design.9. This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance). 10. Off Isolation =  $20 \log_{10} [V_A/V_{Bn}]$ .



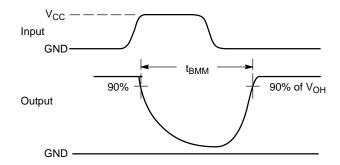
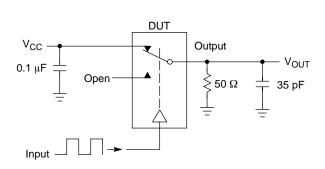


Figure 2. t<sub>BBM</sub> (Time Break-Before-Make)



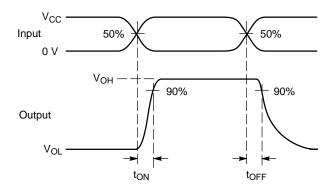
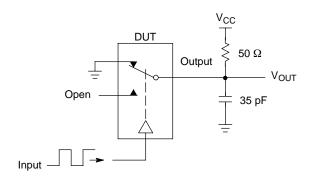


Figure 3. t<sub>ON</sub>/t<sub>OFF</sub>



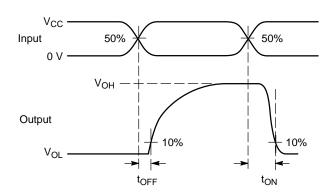
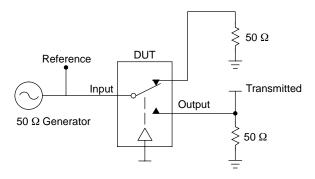


Figure 4. t<sub>ON</sub>/t<sub>OFF</sub>



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch.  $V_{\rm ISO}$ , Bandwidth and  $V_{\rm ONL}$  are independent of the input signal direction.

$$\begin{split} &V_{ISO} = \text{Off Channel Isolation} = 20 \text{ Log} \left( \frac{V_{OUT}}{V_{IN}} \right) \text{ } \text{ for } V_{IN} \text{ at } 100 \text{ kHz} \\ &V_{ONL} = \text{On Channel Loss} = 20 \text{ Log} \left( \frac{V_{OUT}}{V_{IN}} \right) \text{ } \text{ for } V_{IN} \text{ at } 100 \text{ kHz to } 50 \text{ MHz} \end{split}$$

Bandwidth (BW) = the frequency 3 dB below  $V_{ONL}$ 

 $V_{CT}$  = Use  $V_{ISO}$  setup and test to all other switch analog input/outputs terminated with 50  $\Omega$ 

Figure 5. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V<sub>ONL</sub>

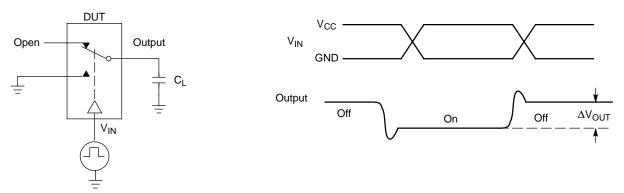


Figure 6. Charge Injection: (Q)

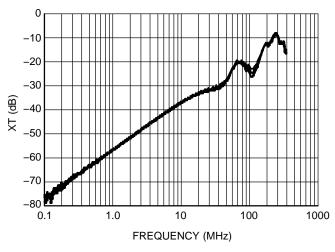


Figure 7. Cross Talk vs. Frequency
@ V<sub>CC</sub> = 4.5 V

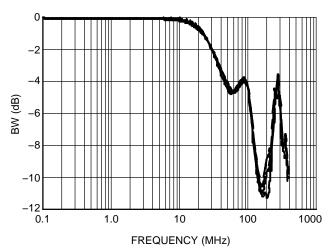


Figure 8. Bandwidth vs. Frequency

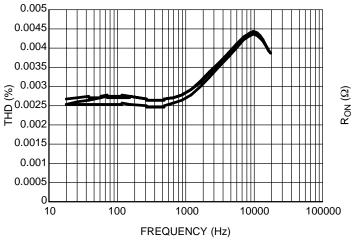


Figure 9. Total Harmonic Distortion

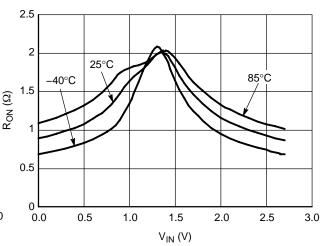


Figure 10. On–Resistance vs. Input Voltage  $@V_{CC} = 2.7 \text{ V}$ 

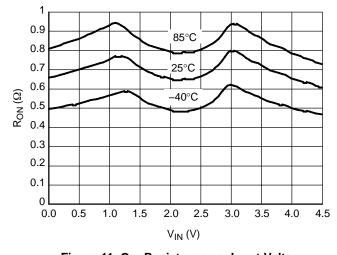


Figure 11. On–Resistance vs. Input Voltage @ V<sub>CC</sub> = 4.5 V

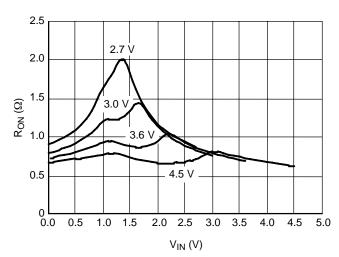


Figure 12. On-Resistance vs. Input Voltage

#### **DEVICE ORDERING INFORMATION**

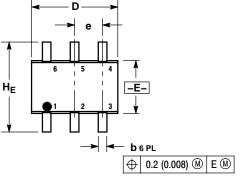
		Devi	ce Nomenc				
Device Order Number	Circuit Indicator	Technology	Device Function	Package Suffix	Tape & Reel Suffix	Package Type	Tape & Reel Size <sup>†</sup>
NLAS4157DFT2G	NL	AS	4157	DFT	2	SC-88 (Pb-Free)	3000 / Tape & Reel

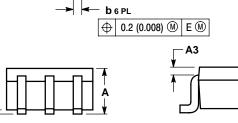
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **PACKAGE DIMENSIONS**

## SC-88/SC70-6/SOT-363

CASE 419B-02 ISSUE V

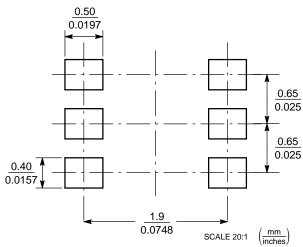




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	MIL	LIMETE	ERS		3	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3		0.20 REF			0.008 RI	ΕF
b	0.10	0.21	0.30	0.004	0.008	0.012
С	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
Е	1.15	1.25	1.35	0.045	0.049	0.053
е		0.65 BS	С	0	O	
Г	0.10	0.20	0.30	0.004	0.008	0.012
HF	2.00	2.10	2.20	0.078	0.082	0.086

#### **SOLDERING FOOTPRINT\***



<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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